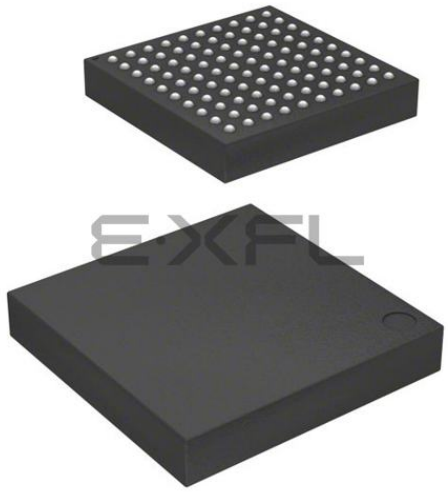

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, IrDA, SCI, SPI, SSI, USB OTG
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	80
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 17x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51138adlj-20

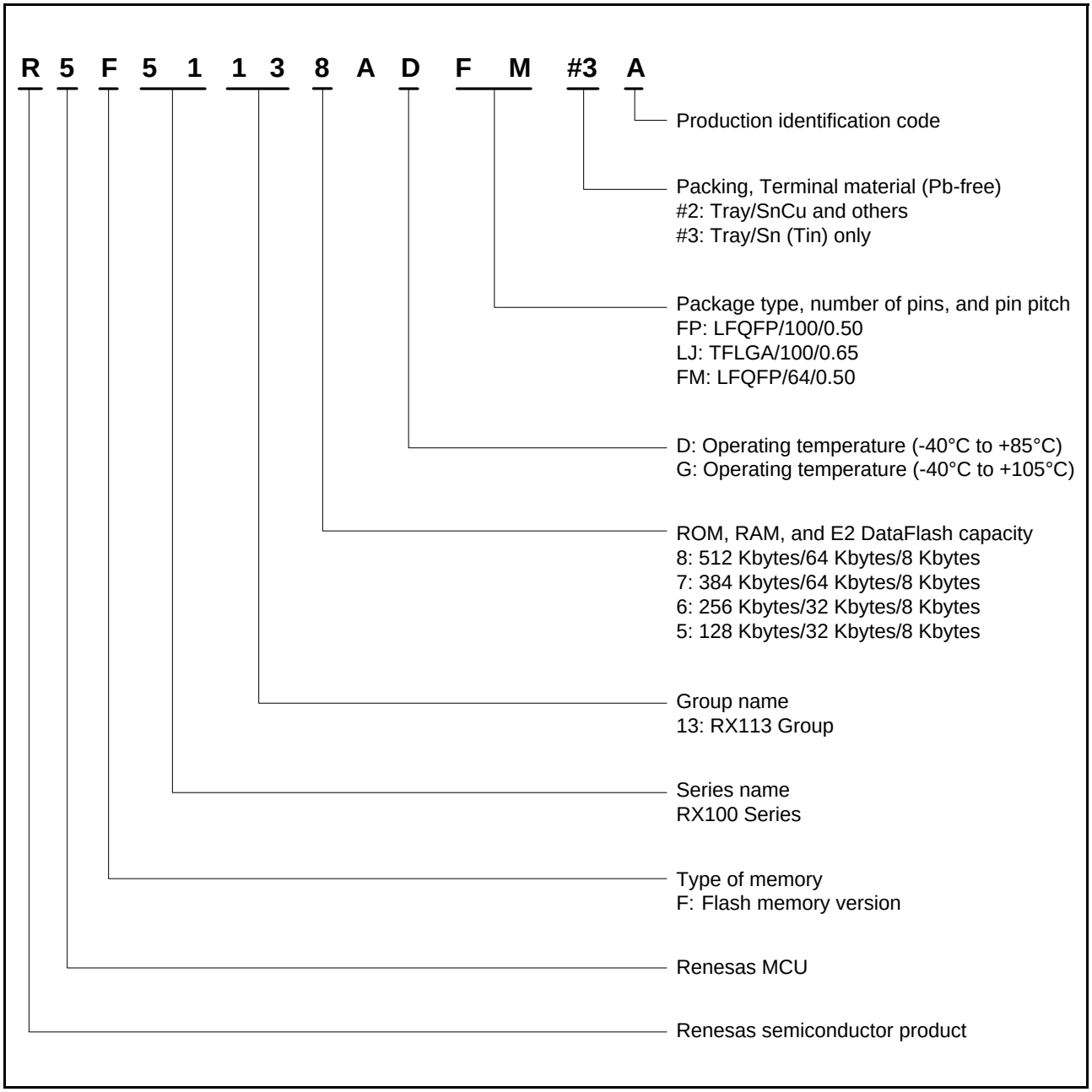
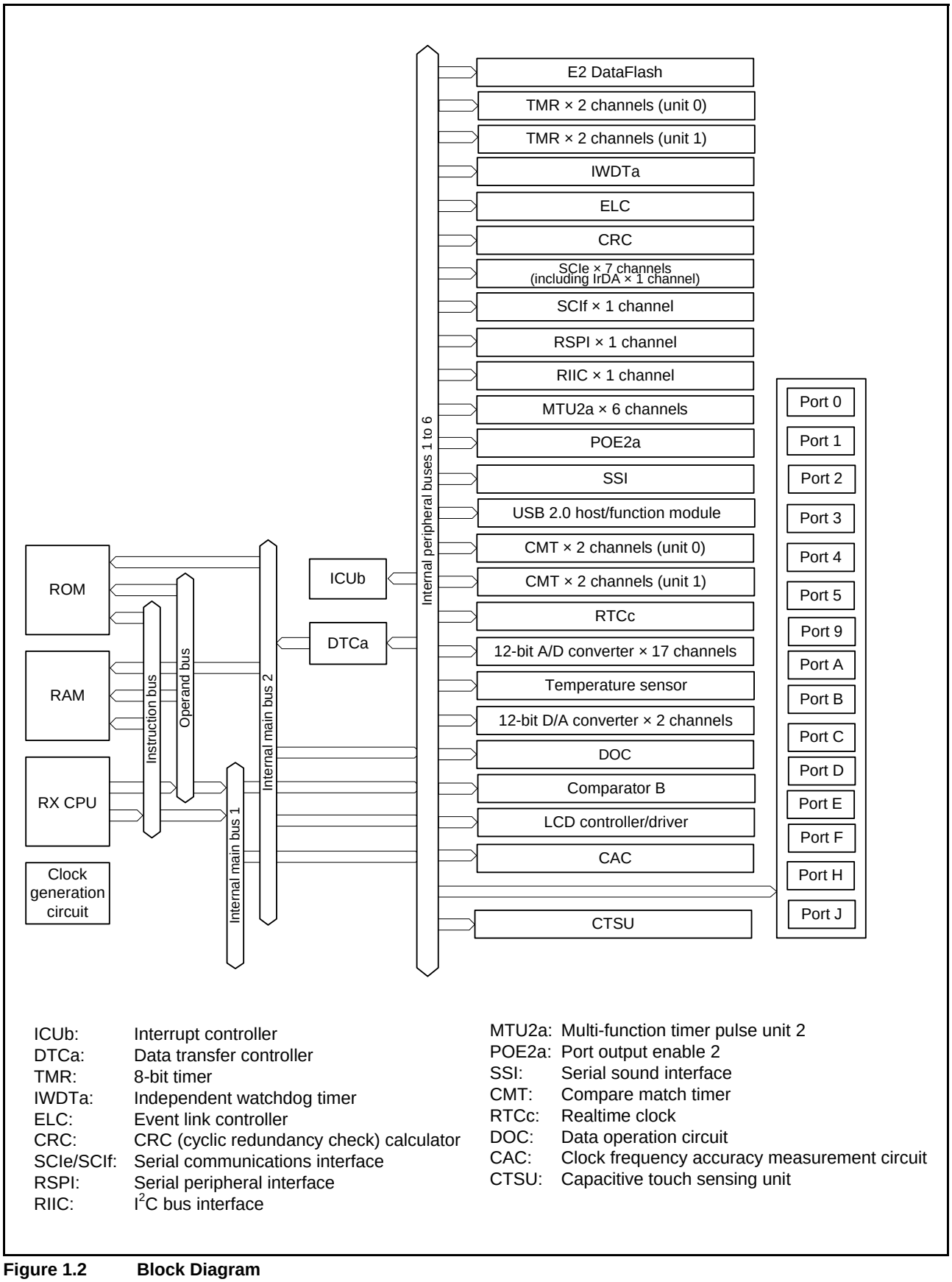


Figure 1.1 How to Read the Product Part No., Memory Capacity, and Package Type

1.3 Block Diagram

Figure 1.2 shows a block diagram.



ICUb: Interrupt controller
DTCa: Data transfer controller
TMR: 8-bit timer
IWDTa: Independent watchdog timer
ELC: Event link controller
CRC: CRC (cyclic redundancy check) calculator
SCIe/SCIf: Serial communications interface
RSPI: Serial peripheral interface
RIIC: I^2C bus interface

MTU2a: Multi-function timer pulse unit 2
POE2a: Port output enable 2
SSI: Serial sound interface
CMT: Compare match timer
RTCc: Realtime clock
DOC: Data operation circuit
CAC: Clock frequency accuracy measurement circuit
CTSU: Capacitive touch sensing unit

Figure 1.2 Block Diagram

Table 1.4 Pin Functions (4/4)

Classifications	Pin Name	I/O	Description
Comparator B	CMPB0	Input	Input pin for the analog signal to be processed by comparator B0.
	CVREFB0	Input	Analog reference voltage supply pin for comparator B0.
	CMPB1	Input	Input pin for the analog signal to be processed by comparator B1.
	CVREFB1	Input	Analog reference voltage supply pin for comparator B1.
	CMPOB0	Output	Output pin for comparator B0.
	CMPOB1	Output	Output pin for comparator B1.
LCD	VL1, VL2, VL3, VL4	I/O	Voltage pin for driving the LCD.
	CAPH, CAPL	I/O	Capacitor connection pin for the LCD controller/driver.
	COM0 to COM7	Output	Common signal output pins for the LCD controller/driver.
	SEG00 to SEG39	Output	Segment signal output pins for the LCD controller/driver.
CTSU	TS0 to TS11	Input	Capacitive touch detection pins (touch pins).
	TSCAP	I/O	Secondary power supply pin for the touch driver.
I/O ports	P02, P04, P07	I/O	3-bit input/output pins.
	P10 to P17	I/O	8-bit input/output pins.
	P20 to P27	I/O	8-bit input/output pins.
	P30 to P32, P35	I/O	4-bit input/output pins (P35 input pin).
	P40 to P44, P46	I/O	6-bit input/output pins.
	P50 to P56	I/O	7-bit input/output pins.
	P90 to P92	I/O	3-bit input/output pins.
	PA0 to PA7	I/O	8-bit input/output pins.
	PB0 to PB7	I/O	8-bit input/output pins.
	PC0 to PC7	I/O	8-bit input/output pins.
	PD0 to PD4	I/O	5-bit input/output pins.
	PE0 to PE7	I/O	8-bit input/output pins.
	PF6, PF7	I/O	2-bit input/output pins.
	PH7	Input	1-bit input pin.
	PJ0, PJ2, PJ3, PJ6, PJ7	I/O	5-bit input/output pins.

Note 1. For external clock input.

Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (2/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC, TMR)	Communication (SCIe, SCIf, RSPI, RIIC, USB, SSI)	LCD, Touch	Others
D9		PA1	MTIOC0B/MTCLKC/ RTCOUT	SCK5/SSLA2	SEG23	
D10		PA0	MTIOC4A	SSLA1	SEG24	CACREF
E1		P30	MTIOC4B/POE8#/TMRI3	RXD1/SMISO1/SSCL1	CAPH	IRQ0
E2		P31	MTIOC4D/TMCI2	CTS1#/RTS1#/SS1#	CAPL	IRQ1
E3		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ USB0_VBUSEN/TXD6/SMOSI6/ SSDA6	TSCAP	
E4		P20	MTIOC1A/TMRI0	TXD0/SMOSI0/SSDA0	TS9	
E5		P40*2				AN000
E6		PA2		RXD5/SMISO5/SSCL5/IRRXD5/ SSLA3	SEG22	
E7		PA4	MTIOC2B/MTIC5U/ MTCLKA/TMRI0	TXD5/SMOSI5/SSDA5/IRTXD5/ SSLA0/CTS8#/RTS8#/SS8#	SEG20	IRQ5/CVREFB1
E8		PA5		SCK8	SEG19	
E9		PA3	MTIOC0D/MTIOC1B/ MTCLKD/POE0#	RXD5/SMISO5/SSCL5/IRRXD5/ MISOA	SEG21	IRQ6/CMPB1
E10	VSS					
F1	XCOUT					
F2	UPSEL	P35				NMI
F3	RES#					
F4		P27	MTIOC2B/TMCI3	SCK12/SCK1/RXD6/SMISO6/ SSCL6	TS10	IRQ3/ ADTRG0#/ CACREF/ CMPA2
F5		P56	MTIOC1A/MTIC5W/ POE2#	TXD1/SMOSI1/SSDA1	SEG4	IRQ5
F6		PB4		CTS9#/RTS9#/SS9#	SEG14	
F7		PA7		TXD8/SMOSI8/SSDA8	SEG18	
F8		PB0	MTIOC0C/MTIC5W/ RTCOUT	SCL0/RSPCKA/RXD6/SMISO6/ SSCL6		IRQ2/ADTRG0#
F9		PA6	MTIC5V/MTCLKB/ MTIOC2A/POE2#/TMCI3	CTS5#/RTS5#/SS5#/SDA0/MOSIA/ RXD8/SMISO8/SSCL8		IRQ3
F10	VCC					
G1	XCIN	PH7				
G2	UB#	P14	MTIOC0A/MTIOC3A/ MTCLKA/TMRI2	CTS1#/RTS1#/SS1#/SSLA0/ TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12/USB0_OVRCURA		IRQ4
G3		P12	TMCI1	SCK12/SCK0	SEG01	IRQ2
G4	MD					FINED
G5		P10	MTIC5V/POE1#	TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12/TXD0/SMOSI0/SSDA0	SEG03	IRQ6
G6		P50	MTIOC2A	MOSIA/TXD2/SMOSI2/SSDA2	SEG08	
G7		PB5	MTIOC1B/MTIOC2A/ POE1#/TMRI1	SCK9/SSISCK0	SEG13/ COM6	
G8		PB2		CTS6#/RTS6#/SS6#	SEG16	
G9		PB1	MTIOC0C/MTIOC4C/ TMCI0	TXD6/SMOSI6/SSDA6/SSIWS0	SEG17	IRQ4
G10		PB3	MTIOC0A/MTIOC3B/ MTIOC4A/POE3#/TMO0	SCK6/AUDIO_MCLK/ USB0_OVRCURA	SEG15/ COM7	

Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (3/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC, TMR)	Communication (SCIe, SCIf, RSPI, RIIC, USB, SSI)	LCD, Touch	Others
H1	XTAL					
H2	EXTAL					
H3		P15	MTIOC0B/MTCLKB/ TMCI2	RXD1/SMISO1/SSCL1/RSPCKA		IRQ5/CLKOUT/ CACREF
H4		P13	MTIOC0B/TMO3	CTS12#/RTS12#/SS12#/CTS0#/ RTS0#/SS0#	SEG00	IRQ3
H5		P11	MTIC5U/POE0#	RXD12/RXDX12/SMISO12/ SSCL12/RXD0/SMISO0/SSCL0	SEG02	IRQ7
H6		P51	MTIOC4C	RSPCKA/SCK2	SEG07	
H7		PC0	MTIOC3C	CTS5#/RTS5#/SS5#/SSLA1	SEG10	
H8		PC1	MTIOC3A	SCK5/SSLA2	SEG09	
H9		PB6	MTIOC3D	RXD9/SMISO9/SSCL9/SSIRXD0	SEG12/ COM5	
H10		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9/SSITXD0	SEG11/ COM4	
J1	VCL					
J2		P17	MTIOC0C/MTIOC3A/ MTIOC3B/POE8#/TMO1	SCK1/MISOA/SDA0/RXD12/ RXDX12/SMISO12/SSCL12		IRQ7
J3		P32	MTIOC0C/RTCOUT/ TMO3	TXD6/SMOSI6/SSDA6/CTS6#/ RTS6#/SS6#	TS11	IRQ2
J4	VCC_USB					
J5	VSS_USB					
J6		P52		MISOA/RXD2/SMISO2/SSCL2	SEG06	
J7		P55	MTIOC4D/TMO3		VL1	
J8		PC7	MTIOC3A/MTCLKB/ TMO2	TXD1/SMOSI1/SSDA1/MISOA/ TXD8/SMOSI8/SSDA8/ USB0_OVRCURB	VL3	CACREF
J9		PC4	MTIOC3D/MTCLKC/ POE0#/TMCI1	SSLA0/CTS8#/RTS8#/SS8#/SCK5/ USB0_VBUSEN/USB0_VBUS *1	COM1	IRQ2/CLKOUT
J10		PC2	MTIOC4B	RXD5/SMOSI5/SSCL5/IRRXD5/ SSLA3	COM3	
K1	VSS					
K2	VDD					
K3		P16	MTIOC3C/MTIOC3D/ RTCOUT/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/ SCL0/USB0_VBUS/ USB0_VBUSEN/USB0_OVRCURB		IRQ6/ADTRG0#
K4				USB0_DM		
K5				USB0_DP		
K6		P53	MTIOC2B	SSLA0/CTS2#/RTS2#/SS2#	SEG05	
K7		P54	MTIOC4B/TMCI1		VL2	
K8		PC6	MTIOC3C/MTCLKA/ TMCI2	RXD1/SMISO1/SSCL1/MOSIA/ RXD8/SMISO8/SSCL8/ USB0_EXICEN	VL4	
K9		PC5	MTIOC3B/MTCLKD/ TMRI2	SCK1/RSPCKA/SCK8/USB0_ID	COM0	
K10		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5/IRTXD5	COM2	

Note 1. Not 5 V tolerant.
Note 2. The power source of the I/O buffer for these pins is AVCC0.

Table 4.1 List of I/O Registers (Address Order) (2/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 240Ch	DTC	DTC Module Start Register	DTCST	8	8	2 ICLK
0008 240Eh	DTC	DTC Status Register	DTCSTS	16	16	2 ICLK
0008 7010h	ICU	Interrupt Request Register 016	IR016	8	8	2 ICLK
0008 701Bh	ICU	Interrupt Request Register 027	IR027	8	8	2 ICLK
0008 701Ch	ICU	Interrupt Request Register 028	IR028	8	8	2 ICLK
0008 701Dh	ICU	Interrupt Request Register 029	IR029	8	8	2 ICLK
0008 701Eh	ICU	Interrupt Request Register 030	IR030	8	8	2 ICLK
0008 701Fh	ICU	Interrupt Request Register 031	IR031	8	8	2 ICLK
0008 7020h	ICU	Interrupt Request Register 032	IR032	8	8	2 ICLK
0008 7021h	ICU	Interrupt Request Register 033	IR033	8	8	2 ICLK
0008 7022h	ICU	Interrupt Request Register 034	IR034	8	8	2 ICLK
0008 7024h	ICU	Interrupt Request Register 036	IR036	8	8	2 ICLK
0008 7025h	ICU	Interrupt Request Register 037	IR037	8	8	2 ICLK
0008 7026h	ICU	Interrupt Request Register 038	IR038	8	8	2 ICLK
0008 702Ch	ICU	Interrupt Request Register 044	IR044	8	8	2 ICLK
0008 702Dh	ICU	Interrupt Request Register 045	IR045	8	8	2 ICLK
0008 702Eh	ICU	Interrupt Request Register 046	IR046	8	8	2 ICLK
0008 702Fh	ICU	Interrupt Request Register 047	IR047	8	8	2 ICLK
0008 7039h	ICU	Interrupt Request Register 057	IR057	8	8	2 ICLK
0008 703Ah	ICU	Interrupt Request Register 058	IR058	8	8	2 ICLK
0008 703Bh	ICU	Interrupt Request Register 059	IR059	8	8	2 ICLK
0008 703Ch	ICU	Interrupt Request Register 060	IR060	8	8	2 ICLK
0008 703Dh	ICU	Interrupt Request Register 061	IR061	8	8	2 ICLK
0008 703Eh	ICU	Interrupt Request Register 062	IR062	8	8	2 ICLK
0008 703Fh	ICU	Interrupt Request Register 063	IR063	8	8	2 ICLK
0008 7040h	ICU	Interrupt Request Register 064	IR064	8	8	2 ICLK
0008 7041h	ICU	Interrupt Request Register 065	IR065	8	8	2 ICLK
0008 7042h	ICU	Interrupt Request Register 066	IR066	8	8	2 ICLK
0008 7043h	ICU	Interrupt Request Register 067	IR067	8	8	2 ICLK
0008 7044h	ICU	Interrupt Request Register 068	IR068	8	8	2 ICLK
0008 7045h	ICU	Interrupt Request Register 069	IR069	8	8	2 ICLK
0008 7046h	ICU	Interrupt Request Register 070	IR070	8	8	2 ICLK
0008 7047h	ICU	Interrupt Request Register 071	IR071	8	8	2 ICLK
0008 7058h	ICU	Interrupt Request Register 088	IR088	8	8	2 ICLK
0008 7059h	ICU	Interrupt Request Register 089	IR089	8	8	2 ICLK
0008 705Ah	ICU	Interrupt Request Register 090	IR090	8	8	2 ICLK
0008 705Ch	ICU	Interrupt Request Register 092	IR092	8	8	2 ICLK
0008 705Dh	ICU	Interrupt Request Register 093	IR093	8	8	2 ICLK
0008 7066h	ICU	Interrupt Request Register 102	IR102	8	8	2 ICLK
0008 7067h	ICU	Interrupt Request Register 103	IR103	8	8	2 ICLK
0008 706Ah	ICU	Interrupt Request Register 106	IR106	8	8	2 ICLK
0008 706Ch	ICU	Interrupt Request Register 108	IR108	8	8	2 ICLK
0008 706Dh	ICU	Interrupt Request Register 109	IR109	8	8	2 ICLK
0008 706Eh	ICU	Interrupt Request Register 110	IR110	8	8	2 ICLK
0008 7072h	ICU	Interrupt Request Register 114	IR114	8	8	2 ICLK
0008 7073h	ICU	Interrupt Request Register 115	IR115	8	8	2 ICLK
0008 7074h	ICU	Interrupt Request Register 116	IR116	8	8	2 ICLK
0008 7075h	ICU	Interrupt Request Register 117	IR117	8	8	2 ICLK
0008 7076h	ICU	Interrupt Request Register 118	IR118	8	8	2 ICLK
0008 7077h	ICU	Interrupt Request Register 119	IR119	8	8	2 ICLK
0008 7078h	ICU	Interrupt Request Register 120	IR120	8	8	2 ICLK
0008 7079h	ICU	Interrupt Request Register 121	IR121	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (8/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 800Ch	CMT1	Compare Match Timer Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8010h	CMT	Compare Match Timer Start Register1	CMSTR1	16	16	2 or 3 PCLKB
0008 8012h	CMT2	Compare Match Timer Control Register	CMCR	16	16	2 or 3 PCLKB
0008 8014h	CMT2	Compare Match Counter	CMCNT	16	16	2 or 3 PCLKB
0008 8016h	CMT2	Compare Match Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8018h	CMT3	Compare Match Timer Control Register	CMCR	16	16	2 or 3 PCLKB
0008 801Ah	CMT3	Compare Match Counter	CMCNT	16	16	2 or 3 PCLKB
0008 801Ch	CMT3	Compare Match Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8030h	IWDT	IWDT Refresh Register	IWDTRR	8	8	2 or 3 PCLKB
0008 8032h	IWDT	IWDT Control Register	IWDTCR	16	16	2 or 3 PCLKB
0008 8034h	IWDT	IWDT Status Register	IWDTSR	16	16	2 or 3 PCLKB
0008 8036h	IWDT	IWDT Reset Control Register	IWDTRCR	8	8	2 or 3 PCLKB
0008 8038h	IWDT	IWDT Count Stop Control Register	IWDTCSTPR	8	8	2 or 3 PCLKB
0008 8040h	R12DA	D/A Data Register 0	DADR0	16	16	2 or 3 PCLKB
0008 8042h	R12DA	D/A Data Register 1	DADR1	16	16	2 or 3 PCLKB
0008 8044h	R12DA	D/A Control Register	DACR	8	8	2 or 3 PCLKB
0008 8045h	R12DA	DADRm Format Select Register	DADPR	8	8	2 or 3 PCLKB
0008 8046h	R12DA	D/A A/D Synchronous Start Control Register	DAADSCR	8	8	2 or 3 PCLKB
0008 8047h	R12DA	D/A VREF Control Register	DAVREFCR	8	8	2 or 3 PCLKB
0008 8200h	TMR0	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8201h	TMR1	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8202h	TMR0	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB
0008 8203h	TMR1	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB
0008 8204h	TMR0	Time Constant Register A	TCORA	8	8	2 or 3 PCLKB
0008 8205h	TMR1	Time Constant Register A	TCORA	8	8*1	2 or 3 PCLKB
0008 8206h	TMR0	Time Constant Register B	TCORB	8	8	2 or 3 PCLKB
0008 8207h	TMR1	Time Constant Register B	TCORB	8	8*1	2 or 3 PCLKB
0008 8208h	TMR0	Timer Counter	TCNT	8	8	2 or 3 PCLKB
0008 8209h	TMR1	Timer Counter	TCNT	8	8*1	2 or 3 PCLKB
0008 820Ah	TMR0	Timer Counter Control Register	TCCR	8	8	2 or 3 PCLKB
0008 820Bh	TMR1	Timer Counter Control Register	TCCR	8	8*1	2 or 3 PCLKB
0008 820Ch	TMR0	Time Count Start Register	TCSTR	8	8	2 or 3 PCLKB
0008 8210h	TMR2	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8211h	TMR3	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8212h	TMR2	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB
0008 8213h	TMR3	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB
0008 8214h	TMR2	Time Constant Register A	TCORA	8	8	2 or 3 PCLKB
0008 8215h	TMR3	Time Constant Register A	TCORA	8	8*1	2 or 3 PCLKB
0008 8216h	TMR2	Time Constant Register B	TCORB	8	8	2 or 3 PCLKB
0008 8217h	TMR3	Time Constant Register B	TCORB	8	8*1	2 or 3 PCLKB
0008 8218h	TMR2	Timer Counter	TCNT	8	8	2 or 3 PCLKB
0008 8219h	TMR3	Timer Counter	TCNT	8	8*1	2 or 3 PCLKB
0008 821Ah	TMR2	Timer Control Register	TCCR	8	8	2 or 3 PCLKB
0008 821Bh	TMR3	Timer Control Register	TCCR	8	8*1	2 or 3 PCLKB
0008 821Ch	TMR2	Time Count Start Register	TCSTR	8	8	2 or 3 PCLKB
0008 8280h	CRC	CRC Control Register	CRCCR	8	8	2 or 3 PCLKB
0008 8281h	CRC	CRC Data Input Register	CRCDIR	8	8	2 or 3 PCLKB
0008 8282h	CRC	CRC Data Output Register	CRCDOR	16	16	2 or 3 PCLKB
0008 8300h	RIIC0	I^2C Bus Control Register 1	ICCR1	8	8	2 or 3 PCLKB
0008 8301h	RIIC0	I^2C Bus Control Register 2	ICCR2	8	8	2 or 3 PCLKB
0008 8302h	RIIC0	I^2C Bus Mode Register 1	ICMR1	8	8	2 or 3 PCLKB
0008 8303h	RIIC0	I^2C Bus Mode Register 2	ICMR2	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (12/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 9016h	S12AD	A/D Channel Select Register B1	ADANSB1	16	16	2 or 3 PCLKB
0008 9018h	S12AD	A/D Data Duplication Register	ADDBLDR	16	16	2 or 3 PCLKB
0008 901Ah	S12AD	A/D Temperature Sensor Data Register	ADTSDR	16	16	2 or 3 PCLKB
0008 901Ch	S12AD	A/D Internal Reference Voltage Data Register	ADOCDR	16	16	2 or 3 PCLKB
0008 9020h	S12AD	A/D Data Register 0	ADDR0	16	16	2 or 3 PCLKB
0008 9022h	S12AD	A/D Data Register 1	ADDR1	16	16	2 or 3 PCLKB
0008 9024h	S12AD	A/D Data Register 2	ADDR2	16	16	2 or 3 PCLKB
0008 9026h	S12AD	A/D Data Register 3	ADDR3	16	16	2 or 3 PCLKB
0008 9028h	S12AD	A/D Data Register 4	ADDR4	16	16	2 or 3 PCLKB
0008 902Ah	S12AD	A/D Data Register 5	ADDR5	16	16	2 or 3 PCLKB
0008 902Ch	S12AD	A/D Data Register 6	ADDR6	16	16	2 or 3 PCLKB
0008 902Eh	S12AD	A/D Data Register 7	ADDR7	16	16	2 or 3 PCLKB
0008 9030h	S12AD	A/D Data Register 8	ADDR8	16	16	2 or 3 PCLKB
0008 9032h	S12AD	A/D Data Register 9	ADDR9	16	16	2 or 3 PCLKB
0008 9034h	S12AD	A/D Data Register 10	ADDR10	16	16	2 or 3 PCLKB
0008 9036h	S12AD	A/D Data Register 11	ADDR11	16	16	2 or 3 PCLKB
0008 9038h	S12AD	A/D Data Register 12	ADDR12	16	16	2 or 3 PCLKB
0008 903Ah	S12AD	A/D Data Register 13	ADDR13	16	16	2 or 3 PCLKB
0008 903Ch	S12AD	A/D Data Register 14	ADDR14	16	16	2 or 3 PCLKB
0008 903Eh	S12AD	A/D Data Register 15	ADDR15	16	16	2 or 3 PCLKB
0008 904Ah	S12AD	A/D Data Register 21	ADDR21	16	16	2 or 3 PCLKB
0008 9060h	S12AD	A/D Sampling State Register 0	ADSSTR0	8	8	2 or 3 PCLKB
0008 9061h	S12AD	A/D Sampling State Register L	ADSSTRL	8	8	2 or 3 PCLKB
0008 9070h	S12AD	A/D Sampling State Register T	ADSSTRT	8	8	2 or 3 PCLKB
0008 9071h	S12AD	A/D Sampling State Register O	ADSSTRO	8	8	2 or 3 PCLKB
0008 9073h	S12AD	A/D Sampling State Register 1	ADSSTR1	8	8	2 or 3 PCLKB
0008 9074h	S12AD	A/D Sampling State Register 2	ADSSTR2	8	8	2 or 3 PCLKB
0008 9075h	S12AD	A/D Sampling State Register 3	ADSSTR3	8	8	2 or 3 PCLKB
0008 9076h	S12AD	A/D Sampling State Register 4	ADSSTR4	8	8	2 or 3 PCLKB
0008 9077h	S12AD	A/D Sampling State Register 5	ADSSTR5	8	8	2 or 3 PCLKB
0008 9078h	S12AD	A/D Sampling State Register 6	ADSSTR6	8	8	2 or 3 PCLKB
0008 9079h	S12AD	A/D Sampling State Register 7	ADSSTR7	8	8	2 or 3 PCLKB
0008 907Ch	S12AD	A/D High-Side Reference Voltage Control Register	ADHVREFCNT	8	8	2 or 3 PCLKB
0008 9080h	S12AD	A/D Sampling State Register 21	ADSSTR21	8	8	2 or 3 PCLKB
0008 A000h	SCI0	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A001h	SCI0	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A002h	SCI0	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A003h	SCI0	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A004h	SCI0	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 A005h	SCI0	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A006h	SCI0	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A007h	SCI0	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A008h	SCI0	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A009h	SCI0	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A00Ah	SCI0	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A00Bh	SCI0	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A00Ch	SCI0	I^2C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A00Dh	SCI0	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (22/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
000A 0840h	LCDC	LCD Display Data Register 00	SEG00	8	8	1 or 2 PCLKB
000A 0841h	LCDC	LCD Display Data Register 01	SEG01	8	8	1 or 2 PCLKB
000A 0842h	LCDC	LCD Display Data Register 02	SEG02	8	8	1 or 2 PCLKB
000A 0843h	LCDC	LCD Display Data Register 03	SEG03	8	8	1 or 2 PCLKB
000A 0844h	LCDC	LCD Display Data Register 04	SEG04	8	8	1 or 2 PCLKB
000A 0845h	LCDC	LCD Display Data Register 05	SEG05	8	8	1 or 2 PCLKB
000A 0846h	LCDC	LCD Display Data Register 06	SEG06	8	8	1 or 2 PCLKB
000A 0847h	LCDC	LCD Display Data Register 07	SEG07	8	8	1 or 2 PCLKB
000A 0848h	LCDC	LCD Display Data Register 08	SEG08	8	8	1 or 2 PCLKB
000A 0849h	LCDC	LCD Display Data Register 09	SEG09	8	8	1 or 2 PCLKB
000A 084Ah	LCDC	LCD Display Data Register 10	SEG10	8	8	1 or 2 PCLKB
000A 084Bh	LCDC	LCD Display Data Register 11	SEG11	8	8	1 or 2 PCLKB
000A 084Ch	LCDC	LCD Display Data Register 12	SEG12	8	8	1 or 2 PCLKB
000A 084Dh	LCDC	LCD Display Data Register 13	SEG13	8	8	1 or 2 PCLKB
000A 084Eh	LCDC	LCD Display Data Register 14	SEG14	8	8	1 or 2 PCLKB
000A 084Fh	LCDC	LCD Display Data Register 15	SEG15	8	8	1 or 2 PCLKB
000A 0850h	LCDC	LCD Display Data Register 16	SEG16	8	8	1 or 2 PCLKB
000A 0851h	LCDC	LCD Display Data Register 17	SEG17	8	8	1 or 2 PCLKB
000A 0852h	LCDC	LCD Display Data Register 18	SEG18	8	8	1 or 2 PCLKB
000A 0853h	LCDC	LCD Display Data Register 19	SEG19	8	8	1 or 2 PCLKB
000A 0854h	LCDC	LCD Display Data Register 20	SEG20	8	8	1 or 2 PCLKB
000A 0855h	LCDC	LCD Display Data Register 21	SEG21	8	8	1 or 2 PCLKB
000A 0856h	LCDC	LCD Display Data Register 22	SEG22	8	8	1 or 2 PCLKB
000A 0857h	LCDC	LCD Display Data Register 23	SEG23	8	8	1 or 2 PCLKB
000A 0858h	LCDC	LCD Display Data Register 24	SEG24	8	8	1 or 2 PCLKB
000A 0859h	LCDC	LCD Display Data Register 25	SEG25	8	8	1 or 2 PCLKB
000A 085Ah	LCDC	LCD Display Data Register 26	SEG26	8	8	1 or 2 PCLKB
000A 085Bh	LCDC	LCD Display Data Register 27	SEG27	8	8	1 or 2 PCLKB
000A 085Ch	LCDC	LCD Display Data Register 28	SEG28	8	8	1 or 2 PCLKB
000A 085Dh	LCDC	LCD Display Data Register 29	SEG29	8	8	1 or 2 PCLKB
000A 085Eh	LCDC	LCD Display Data Register 30	SEG30	8	8	1 or 2 PCLKB
000A 085Fh	LCDC	LCD Display Data Register 31	SEG31	8	8	1 or 2 PCLKB
000A 0860h	LCDC	LCD Display Data Register 32	SEG32	8	8	1 or 2 PCLKB
000A 0861h	LCDC	LCD Display Data Register 33	SEG33	8	8	1 or 2 PCLKB
000A 0862h	LCDC	LCD Display Data Register 34	SEG34	8	8	1 or 2 PCLKB
000A 0863h	LCDC	LCD Display Data Register 35	SEG35	8	8	1 or 2 PCLKB
000A 0864h	LCDC	LCD Display Data Register 36	SEG36	8	8	1 or 2 PCLKB
000A 0865h	LCDC	LCD Display Data Register 37	SEG37	8	8	1 or 2 PCLKB
000A 0866h	LCDC	LCD Display Data Register 38	SEG38	8	8	1 or 2 PCLKB
000A 0867h	LCDC	LCD Display Data Register 39	SEG39	8	8	1 or 2 PCLKB
000A 0900h	CTSU	CTSU Control Register 0	CTSUCR0	8	8	1 or 2 PCLKB
000A 0901h	CTSU	CTSU Control Register 1	CTSUCR1	8	8	1 or 2 PCLKB
000A 0902h	CTSU	CTSU Synchronous Noise Reduction Setting Register	CTSUSDPRS	8	8	1 or 2 PCLKB
000A 0903h	CTSU	CTSU Sensor Stabilization Wait Time Register	CTSUSST	8	8	1 or 2 PCLKB
000A 0904h	CTSU	CTSU Measurement Channel Register 0	CTSUMCH0	8	8	1 or 2 PCLKB
000A 0905h	CTSU	CTSU Measurement Channel Register 1	CTSUMCH1	8	8	1 or 2 PCLKB
000A 0906h	CTSU	CTSU Channel Enable Control Register 0	CTSUCHAC0	8	8	1 or 2 PCLKB
000A 0907h	CTSU	CTSU Channel Enable Control Register 1	CTSUCHAC1	8	8	1 or 2 PCLKB
000A 090Bh	CTSU	CTSU Channel Transmit/Receive Control Register 0	CTSUCHTRC0	8	8	1 or 2 PCLKB
000A 090Ch	CTSU	CTSU Channel Transmit/Receive Control Register 1	CTSUCHTRC1	8	8	1 or 2 PCLKB
000A 0910h	CTSU	CTSU High-Pass Noise Reduction Control Register	CTSUDCLKC	8	8	1 or 2 PCLKB
000A 0911h	CTSU	CTSU Status Register	CTSUST	8	8	1 or 2 PCLKB

Table 5.7 DC Characteristics (5) (2/2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ *4	Max	Unit	Test Conditions
Supply current*1	Low-speed operating mode	Normal operating mode	No peripheral operation*8	ICLK = 32.768 kHz	I_{CC}	4.3	—	μA	
			All peripheral operation: Normal*9, *10	ICLK = 32.768 kHz		15.0	—		
			All peripheral operation: Max.*9, *10	ICLK = 32.768kHz		—	62		
		Sleep mode	No peripheral operation*8	ICLK = 32.768 kHz		2.3	—		
			All peripheral operation: Normal*9	ICLK = 32.768 kHz		8.6	—		
		Deep sleep mode	No peripheral operation*8	ICLK = 32.768 kHz		1.7	—		
			All peripheral operation: Normal*9	ICLK = 32.768 kHz		7.0	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.
Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to divided by 64.
Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to the same frequency as ICLK.
Note 4. Values when VCC = 3.3 V.
Note 5. This is the increase for programming or erasure of the ROM or E2 DataFlash during program execution.
Note 6. Clock supply to the peripheral functions is stopped. The clock source is PLL when ICLK = 12 MHz, and HOCO otherwise. FCLK and PCLK are set to divided by 64.
Note 7. Clocks are supplied to the peripheral functions. The clock source is PLL when ICLK = 12 MHz, and HOCO otherwise. FCLK and PCLK are set to the same frequency as ICLK.
Note 8. Clock supply to the peripheral functions is stopped. The clock source is the sub-clock oscillator. FCLK and PCLK are set to divided by 64.
Note 9. Clocks are supplied to the peripheral functions. The clock source is the sub-clock oscillator. FCLK and PCLK are set to the same frequency as ICLK.
Note 10. Values when the MSTPCRA.MSTPA17 bit (12-bit A/D converter module stop bit) is set to “transition to the module stop state is made”.

Table 5.14 DC Characteristics (12)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Permissible error of VCL pin external capacitance	C_{VCL}	1.4	4.7	7.0	μF	

Note: The recommended capacitance is 4.7 μF. Variations in connected capacitors should be within the above range.

Table 5.15 Permissible Output Currents (1)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V,
T_a = –40 to +85°C (D version)

Item		Symbol	Max.	Unit
Permissible output low current (average value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	I_{OL}	0.4	mA
	Ports other than above		8.0	
Permissible output low current (maximum value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7		0.4	
	Ports other than above		8.0	
Permissible output low current	Total of ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	ΣI_{OL}	2.4	
	Total of ports P02, P04, P07, P20 to P27, P30, P31, PJ0, PJ2, PJ3		30	
	Total of ports P10 to P17, port P32, ports P50 to P56, ports PB0 to PB7, ports PC0 to PC7		30	
	Total of ports PA0 to PA7, ports PD0 to PD4, ports PE0 to PE7, ports PF6, PF7		30	
	Total of all output pins		60	
Permissible output high current (average value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	I_{OH}	–0.1	
	Ports other than above		–4.0	
Permissible output high current (maximum value per pin)	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7		–0.1	
	Ports other than above		–4.0	
Permissible output high current	Total of ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	ΣI_{OH}	–0.6	
	Total of ports P02, P04, P07, P20 to P27, P30, P31, PJ0, PJ2, PJ3		–10	
	Total of ports P10 to P17, port P32, ports P50 to P56, ports PB0 to PB7, ports PC0 to PC7		–15	
	Total of ports PA0 to PA7, ports PD0 to PD4, ports PE0 to PE7, ports PF6, PF7		–15	
	Total of all output pins		–40	

Note: Do not exceed the permissible total supply current.

5.2.2 Standard I/O Pin Output Characteristics (2)

Figure 5.11 to Figure 5.13 show the characteristics of the RIIC output pin.

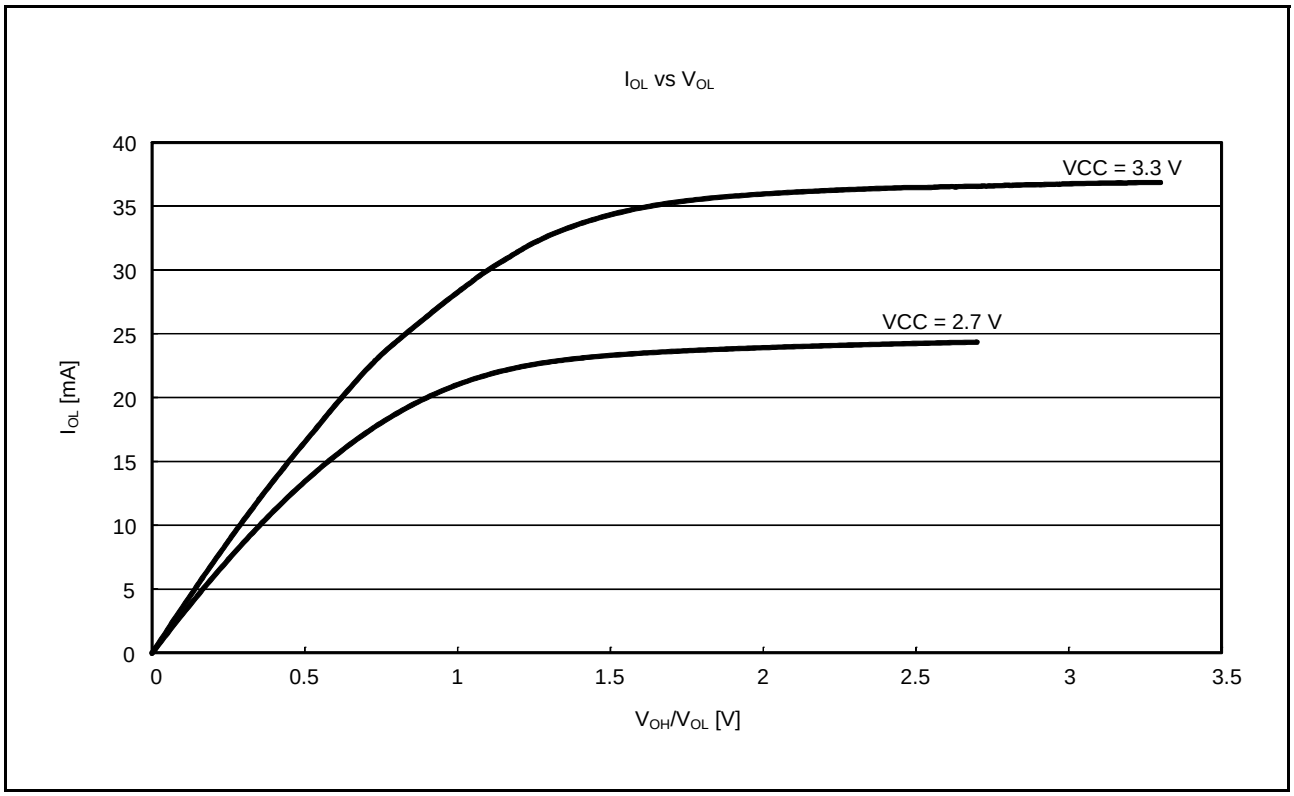


Figure 5.11 V_{OL} and I_{OL} Voltage Characteristics of RIIC Output Pin at T_a = 25°C (Reference Data)

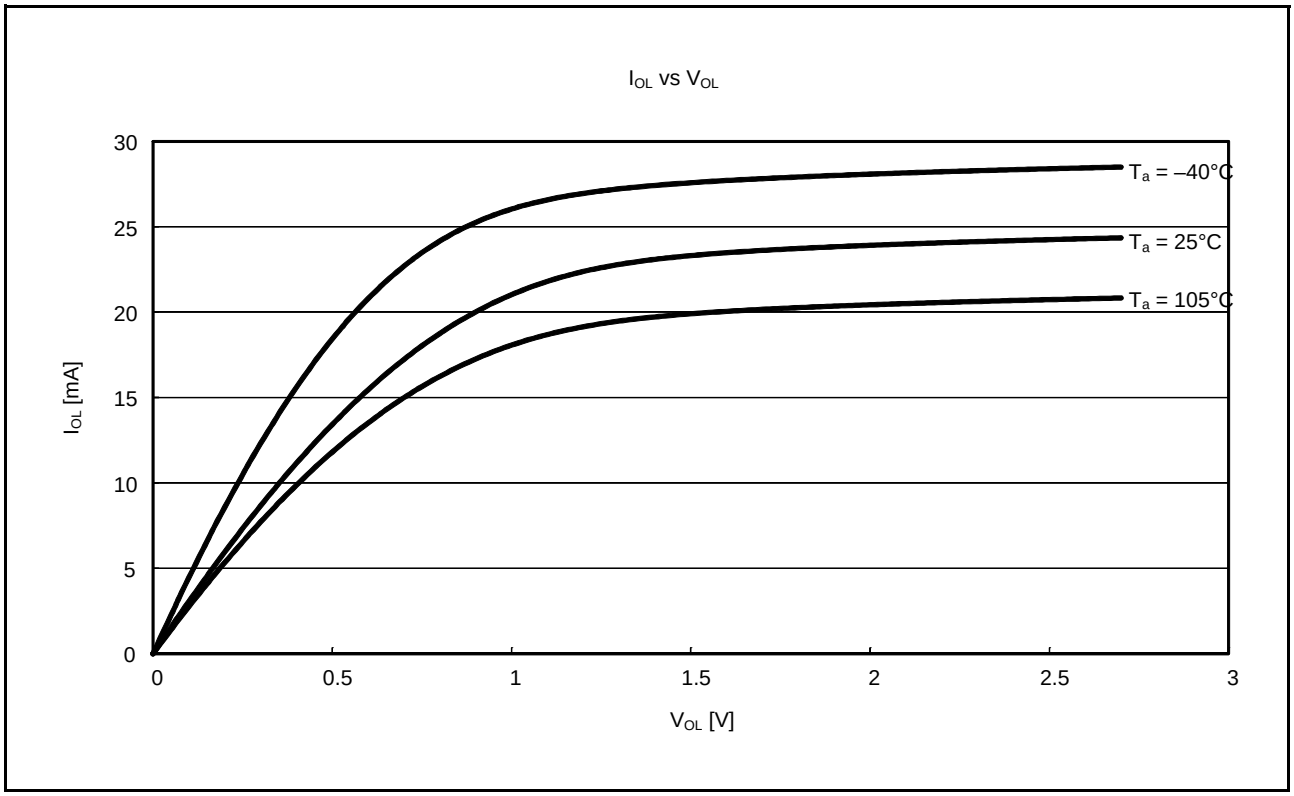


Figure 5.12 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 2.7 V (Reference Data)

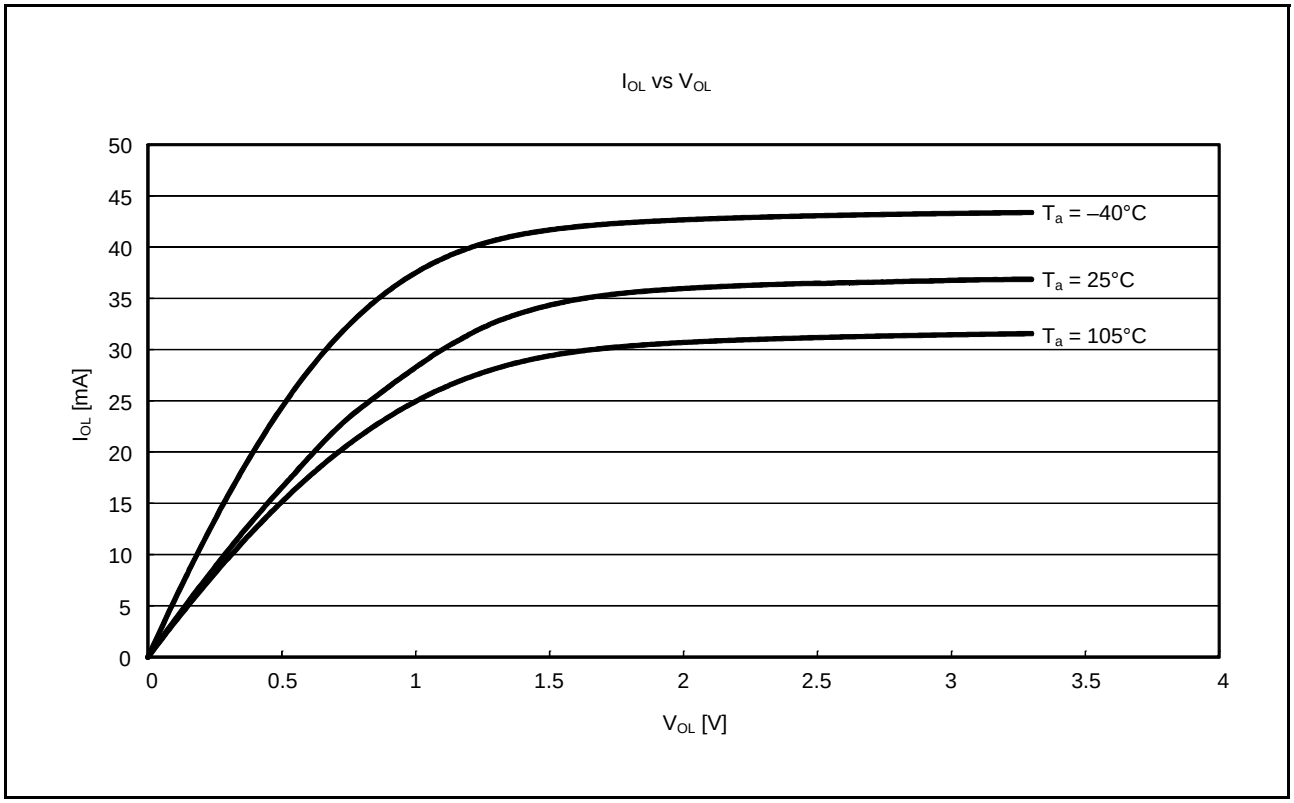


Figure 5.13 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 3.3 V (Reference Data)

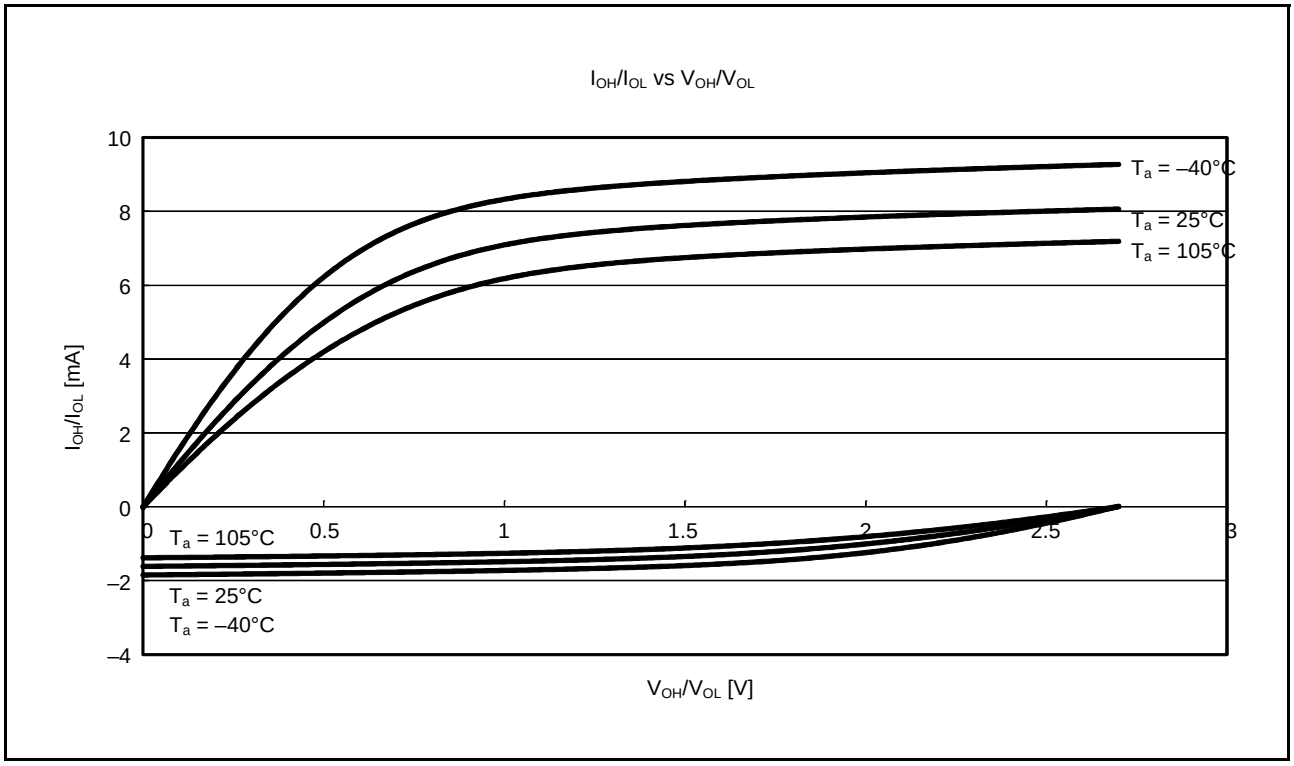


Figure 5.16 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of Ports P40 to P44, P46, Ports P90 to P92, Ports PJ6, PJ7 at VCC = 2.7 V (Reference Data)

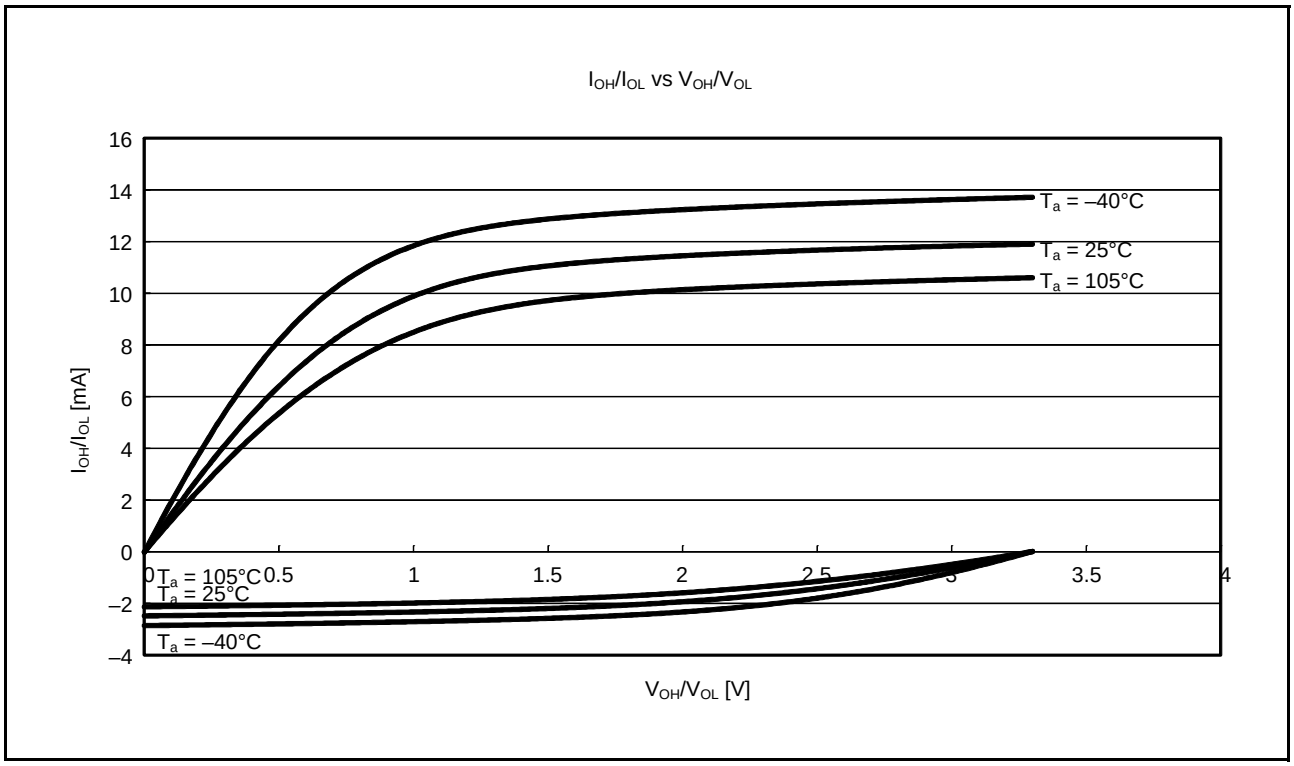


Figure 5.17 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of Ports P40 to P44, P46, Ports P90 to P92, Ports PJ6, PJ7 at VCC = 3.3 V (Reference Data)

5.3 AC Characteristics

5.3.1 Clock Timing

Table 5.19 Operation Frequency Value (High-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	16	32	32	MHz
	FlashIF clock (FCLK)*1, *2		8	16	32	32	
	Peripheral module clock (PCLKB)		8	16	32	32	
	Peripheral module clock (PCLKD)*3		8	16	32	32	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note 2. The frequency accuracy of FCLK should be ±3.5%. Confirm the frequency accuracy of the clock source.
Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.
Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.20 Operation Frequency Value (Middle-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	12	12	12	MHz
	FlashIF clock (FCLK)*1, *2		8	12	12	12	
	Peripheral module clock (PCLKB)		8	12	12	12	
	Peripheral module clock (PCLKD)*3		8	12	12	12	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.
Note 2. The frequency accuracy of FCLK should be ±3.5%.
Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.
Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.21 Operation Frequency Value (Low-Speed Operating Mode)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	VCC			Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	
Maximum operating frequency	System clock (ICLK)	f_{max}	32.768			kHz
	FlashIF clock (FCLK)*1		32.768			
	Peripheral module clock (PCLKB)		32.768			
	Peripheral module clock (PCLKD)*2		32.768			

Note 1. Programming and erasing the flash memory is impossible.
Note 2. The A/D converter cannot be used.

Table 5.32 Timing of On-Chip Peripheral Modules (3)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V,
T_a = –40 to +105°C, C = 30 pF

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)		t_{SPcyc}	4	65536	t_{Pcyc}	Figure 5.42
	SCK clock cycle input (slave)			6	65536	t_{Pcyc}	
	SCK clock high pulse width		t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width		t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time		t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time (master)	2.7 V or above	t_{SU}	65	—	ns	Figure 5.43, Figure 5.45
		1.8 V or above		95	—		
	Data input setup time (slave)			40	—		
	Data input hold time		t_H	40	—	ns	
	SS input setup time		t_{LEAD}	3	—	t_{SPcyc}	
	SS input hold time		t_{LAG}	3	—	t_{SPcyc}	
	Data output delay time (master)		t_{OD}	—	40	ns	
	Data output delay time (slave)	2.7 V or above		—	65		
		1.8 V or above		—	100		
	Data output hold time (master)	2.7 V or above	t_{OH}	–10	—	ns	
		1.8 V or above		–20	—		
	Data output hold time (slave)			–10	—		
	Data rise/fall time		t_{Dr}, t_{Df}	—	20	ns	
	SS input rise/fall time		t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time		t_{SA}	—	6	t_{Pcyc}	Figure 5.47, Figure 5.48
	Slave output release time		t_{REL}	—	6	t_{Pcyc}	

Note 1. t_{Pcyc}: PCLK cycle

Table 5.38 A/D Conversion Characteristics (2)

Conditions: 2.4 V ≤ VCC = VCC_USB ≤ 3.6 V, 2.4 V ≤ AVCC0 ≤ 3.6 V, 2.4 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = VREFL0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		4	—	16	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 16 MHz)	Permissible signal source impedance (Max.) = 1.0 kΩ	2.062 (0.625)*2	—	—	µs	High-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 09h
		2.750 (1.313)*2	—	—	µs	Normal-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±6.0	LSB	
Full-scale error		—	±1.25	±6.0	LSB	
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±3.0	±8.0	LSB	
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.5	±3.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

Table 5.39 A/D Conversion Characteristics (3)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, 1.8 V ≤ VREFH0 ≤ AVCC0,
VSS = AVSS0 = VREFL0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		1	—	8	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 8 MHz)	Permissible signal source impedance (Max.) = 5.0 kΩ	4.875 (1.250)*2	—	—	µs	High-precision channel ADCSR.ADHSC bit = 0 ADSSTRn.SST[7:0] bits = 09h
		6.250 (2.625)*2	—	—	µs	Normal-precision channel ADCSR.ADHSC bit = 0 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±24.0	LSB	
Full-scale error		—	±1.25	±24.0	LSB	
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±2.75	±32.0	LSB	
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.25	±12.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

5.6 D/A Conversion Characteristics

Table 5.43 D/A Conversion Characteristics (1)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, 1.8 V ≤ VREFH ≤ AVCC0, VSS = AVSS0 = VREFL = VSS_USB = 0 V, T_a = –40 to +105°C
Reference voltage = VREFH and VREFL selected

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	12	Bit	
Resistive load	30	—	—	kΩ	
Capacitive load	—	—	50	pF	
Output voltage range*1	0.35	—	VREFH	V	VREFH ≤ AVCC0 - 0.47 V
	0.35	—	AVCC0 - 0.47	V	VREFH > AVCC0 - 0.47 V
DNL differential nonlinearity error	—	±0.5	±1.0	LSB	
INL integral nonlinearity error	—	±2.0	±8.0	LSB	
Offset error	—	—	±20	mV	
Full-scale error	—	—	±20	mV	
Output resistance	—	75	—	Ω	
Conversion time	—	—	30	μs	

Note 1. There are restrictions on AVCC0 and VCC depending on the usage conditions for the 12-bit D/A converter and I/O ports. When using ports J0 and J2 as DA0 and DA1 output, make sure that VCC ≥ D/A output voltage.

Table 5.44 D/A Conversion Characteristics (2)

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 = VREFH ≤ 3.6 V, VSS = AVSS0 = VREFL = VSS_USB = 0 V, T_a = –40 to +105°C
Reference voltage = AVCC0 and AVSS0 selected

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	—	—	12	Bit	
Resistive load	30	—	—	kΩ	
Capacitive load	—	—	50	pF	
Output voltage range*1	0.35	—	AVCC0 - 0.47	V	
DNL differential nonlinearity error	—	±0.5	±2.0	LSB	
INL integral nonlinearity error	—	±2.0	±8.0	LSB	
Offset error	—	—	±30	mV	
Full-scale error	—	—	±30	mV	
Output resistance	—	75	—	Ω	
Conversion time	—	—	30	μs	

Note 1. There are restrictions on AVCC0 and VCC depending on the usage conditions for the 12-bit D/A converter and I/O ports. When using ports J0 and J2 as DA0 and DA1 output, make sure that VCC ≥ D/A output voltage.

5.9.2 Internal Voltage Boosting Method

Table 5.51 Internal Voltage Boosting Method

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
External capacitance connected between CAPH and CAPL pins	C1	0.33	0.47	0.61	µF	
External capacitor connected to V_{L1} pin	C2	0.33	0.47	0.61	µF	
External capacitor connected to V_{L2} pin	C3	0.33	0.47	0.61	µF	
External capacitor connected to V_{L3} pin	C4	0.33	0.47	0.61	µF	
External capacitor connected to V_{L4} pin	C5	0.33	0.47	0.61	µF	

(1) 1/3 Bias Method

Table 5.52 Internal Voltage Boosting Method LCD Characteristics

Conditions: 1.8 V ≤ VCC = VCC_USB ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Conditions		Min.	Typ.	Max.	Unit	Test Conditions
LCD output voltage variation range	V_{L1}	C1 to C4 connected	VLCD = 04h	0.9	1.0	1.08	V	
			VLCD = 05h	0.95	1.05	1.13	V	
			VLCD = 06h	1	1.1	1.18	V	
			VLCD = 07h	1.05	1.15	1.23	V	
			VLCD = 08h	1.1	1.2	1.28	V	
			VLCD = 09h	1.15	1.25	1.33	V	
			VLCD = 0Ah	1.2	1.3	1.38	V	
			VLCD = 0Bh	1.25	1.35	1.43	V	
			VLCD = 0Ch	1.3	1.4	1.48	V	
			VLCD = 0Dh	1.35	1.45	1.53	V	
			VLCD = 0Eh	1.4	1.5	1.58	V	
			VLCD = 0Fh	1.45	1.55	1.63	V	
			VLCD = 10h	1.5	1.6	1.68	V	
			VLCD = 11h	1.55	1.65	1.73	V	
			VLCD = 12h	1.6	1.70	1.78	V	
			VLCD = 13h	1.65	1.75	1.83	V	
Doubler output voltage	V_{L2}	C1 to C3, C5 connected		$2V_{L1}$ - 0.10	$2V_{L1}$	$2V_{L1}$	V	
Tripler output voltage	V_{L3}	C1 to C5 connected		$3V_{L1}$ - 0.15	$3V_{L1}$	$3V_{L1}$	V	
Reference voltage setup time*1	t_{VL1S}			5	—	—	ms	
LCD output voltage variation range*2	t_{VLWT}	C1 to C4 connected		500	—	—	ms	

Note 1. This is the required wait time from when the reference voltage is specified by the VLCD register (or when the internal voltage boosting method is selected (LCDM0.MDSET1 and MDSET0 = 01b) if the default reference voltage value is used) until voltage boosting starts (VLCON = 1).

Note 2. This is the wait time from when voltage boosting is started (VLCON = 1) until display is enabled (LCDON = 1).

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   ¾ The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   ¾ The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   ¾ The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   ¾ When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   ¾ The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.